

ORDERING INFORMATION		
Temp. Range	Package	Part Number
- 55 °C to 125 °C	16-pin CerDIP	DG201BAK
		DG202BAK
- 40 °C to 85 °C	16-pin Plastic DIP	DG201BDJ DG201BDJ-E3
		DG202BDJ DG202BDJ-E3
	16-pin narrow SOIC	DG201BDY DG201BDY-E3 DG201BDY-T1 DG201BDY-T1-E3
		DG202BDY DG202BDY-E3 DG202BDY-T1 DG202BDY-T1-E3
	16-pin TSSOP	DG201BDQ DG201BDQ-E3 DG201BDQ-T1 DG201BDQ-T1-E3
		DG202BDQ DG202BDQ-E3 DG202BDQ-T1 DG202BDQ-T1-E3

ABSOLUTE MAXIMUM RATINGS			
Parameter		Limit	Unit
Voltages Referenced, V <sub>+</sub> to V <sub>-</sub>		44	V
GND		25	
Digital Inputs <sup>a</sup> , V <sub>S</sub> , V <sub>D</sub>		(V <sub>-</sub> ) - 2 to (V <sub>+</sub> ) + 2 or 30 mA, whichever occurs first	
Current (Any terminal)		30	mA
Peak Current S or D (Pulsed at 1 ms, 10 % duty cycle max.)		100	
Storage Temperature	(AK, DK suffix)	- 65 to 150	°C
	(DJ, DY, DQ suffix)	- 65 to 125	
Power Dissipation (Package) <sup>b</sup>	16-pin plastic DIP <sup>c</sup>	470	mW
	16-pin narrow SOIC and TSSOP <sup>d</sup>	640	
	16-pin CerDIP <sup>e</sup>	900	
	LCC-20 <sup>f</sup>	750	

Notes:

- Signals on S<sub>X</sub>, D<sub>X</sub>, or IN<sub>X</sub> exceeding V<sub>+</sub> or V<sub>-</sub> will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- All leads welded or soldered to PC board.
- Derate 6.5 mW/°C above 75 °C.
- Derate 7.6 mW/°C above 75 °C.
- Derate 12 mW/°C above 75 °C.
- Derate 10 mW/°C above 75 °C.

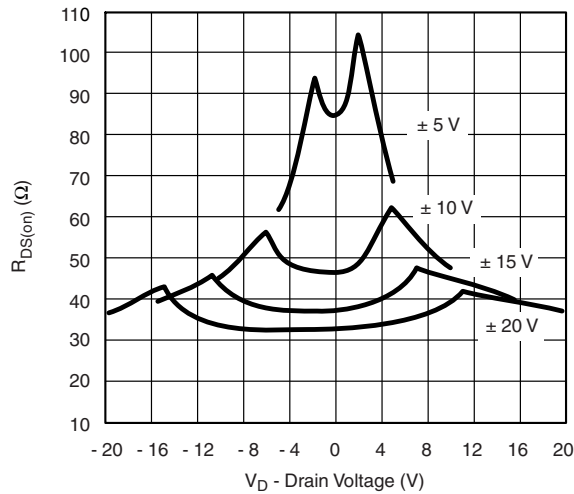
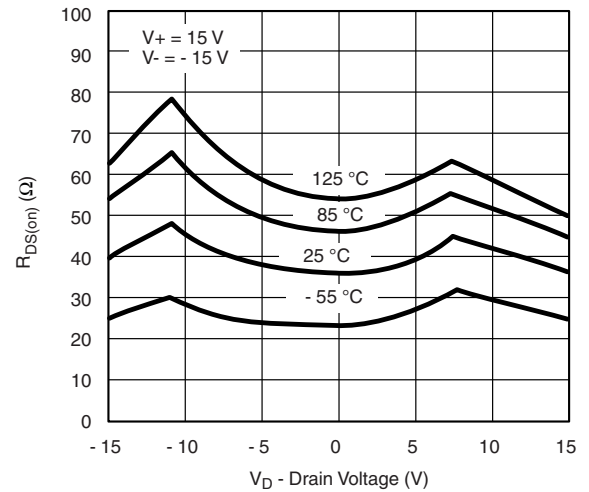
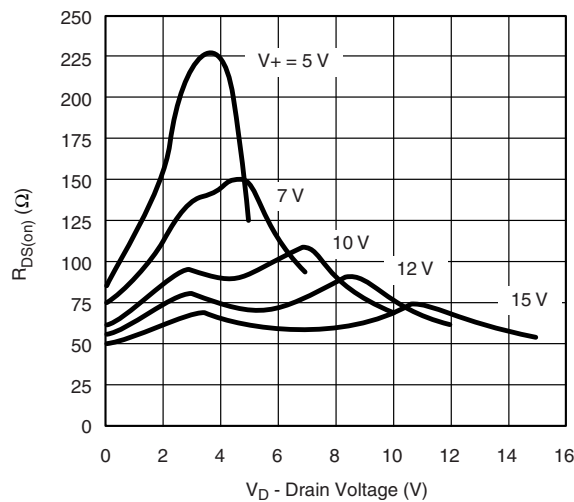
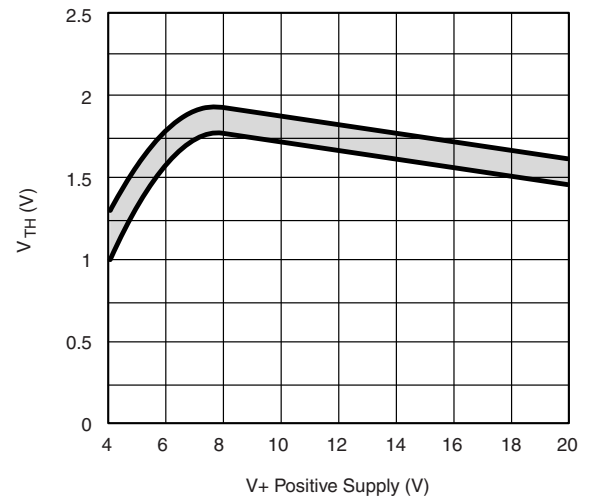
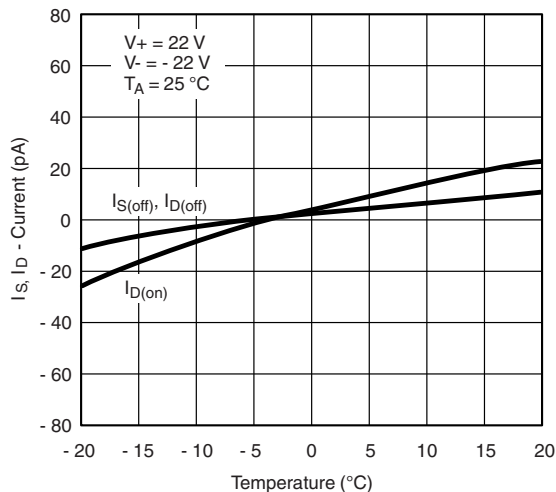
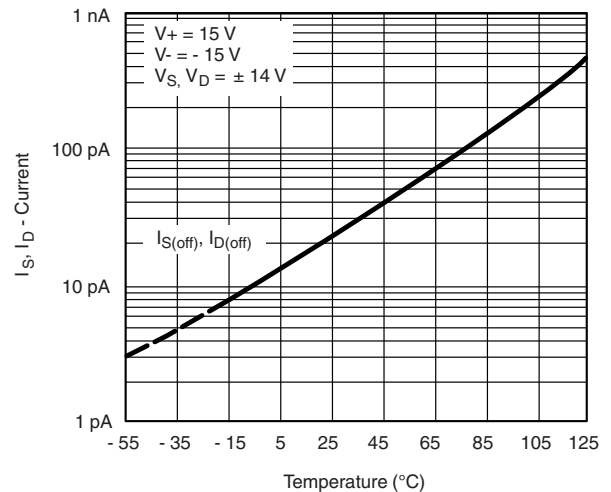


SPECIFICATIONS (for Single Supply) <sup>a</sup>									
Parameter	Symbol	Test Conditions Unless Specified V <sub>+</sub> = 12 V, V <sub>-</sub> = 0 V V <sub>IN</sub> = 2.4 V, 0.8 V <sup>f</sup>	Temp. <sup>b</sup>	Typ. <sup>c</sup>	A Suffix - 55 °C to 125 °C		D Suffix - 40 °C to 85 °C		Unit
					Min. <sup>d</sup>	Max. <sup>d</sup>	Min. <sup>d</sup>	Max. <sup>d</sup>	
Analog Switch									
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>		Full		0	12	0	12	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>D</sub> = 3 V, 8 V, I <sub>S</sub> = 1 mA	Room Full	90		160 200		160 200	Ω
Dynamic Characteristics									
Turn-On Time	t <sub>ON</sub>	V <sub>S</sub> = 8 V see switching time test circuit	Room	120		300		300	ns
Turn-Off Time	t <sub>OFF</sub>		Room	60		200		200	
Charge Injection	Q	C <sub>L</sub> = 1 nF, V <sub>gen</sub> = 6 V R <sub>gen</sub> = 0 Ω	Room	4					pC
Power Supply									
Positive Supply Current	I <sub>+</sub>	V <sub>IN</sub> = 0 or 5 V	Room Full			50 100		50 100	μA
Negative Supply Current	I <sub>-</sub>		Room Full		- 1 - 5		- 1 - 5		
Power Supply Range for Continuous Operation	V <sub>OP</sub>		Full		+ 4.5	+ 25	+ 4.5	+ 25	V

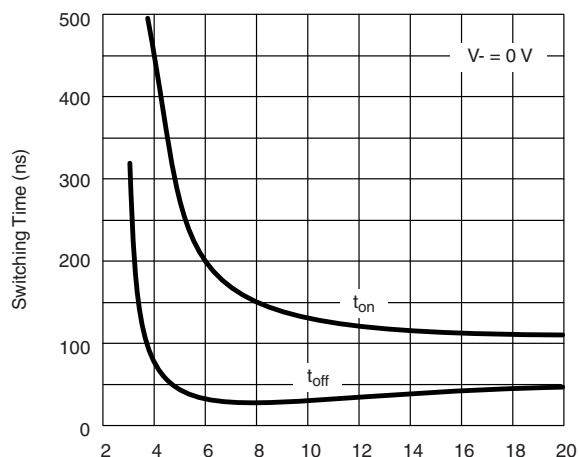
### Notes:

- Refer to PROCESS OPTION FLOWCHART.
- Room = 25 °C, Full = as determined by the operating temperature suffix.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- Guaranteed by design, not subject to production test.
- $V_{IN}$  = input voltage to perform proper function.

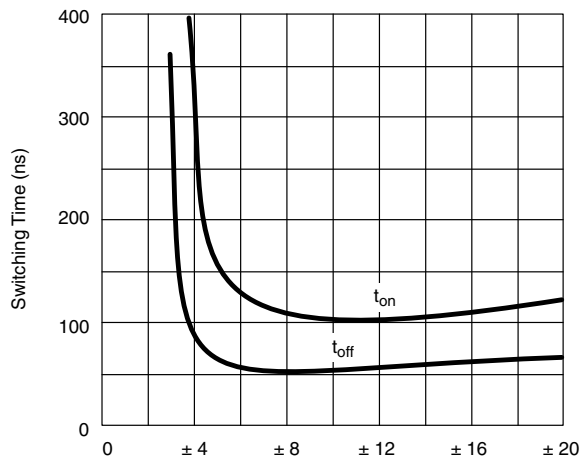
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

 **$R_{DS(on)}$  vs.  $V_D$  and Power Supply Voltages**

 **$R_{DS(on)}$  vs.  $V_D$  and Temperature**

 **$R_{DS(on)}$  vs.  $V_D$  and Single Power Supply Voltages**

**Input Switching Threshold vs. Supply Voltage**

**Leakage Currents vs. Analog Voltage**

**Leakage Currents vs. Temperature**

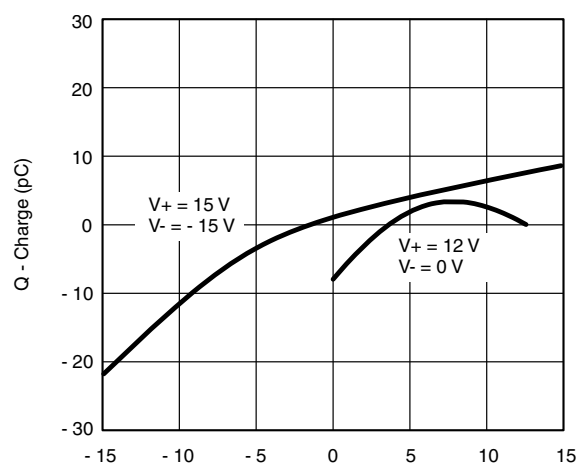
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



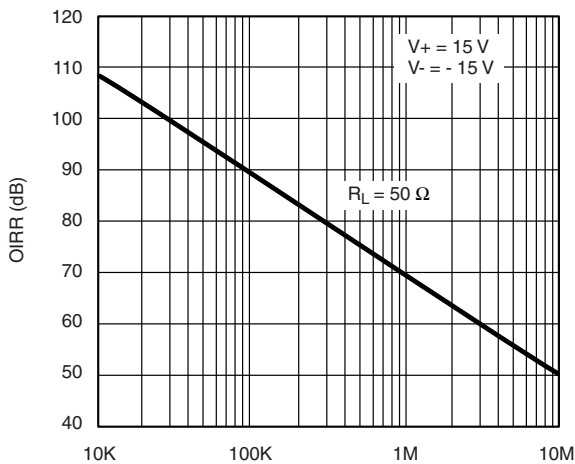
Switching Time vs. Single Supply Voltage



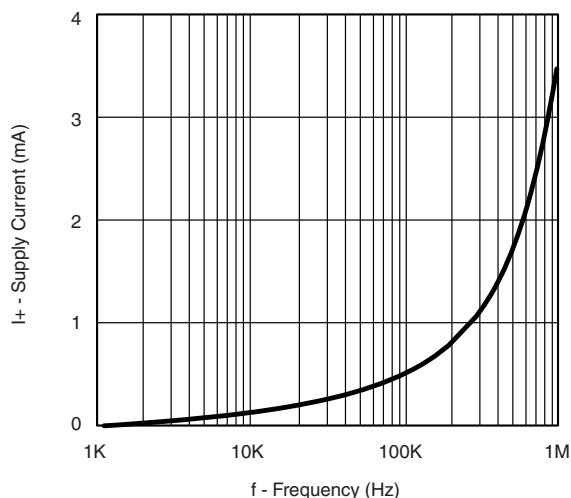
Switching Time vs. Power Supply Voltage



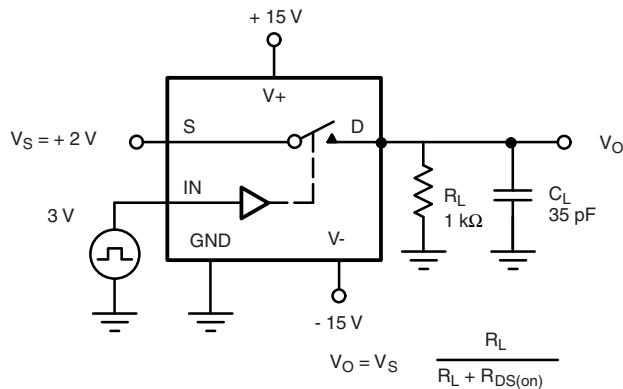
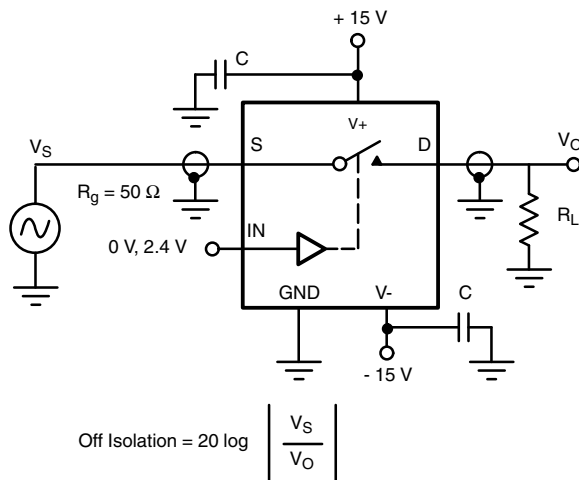
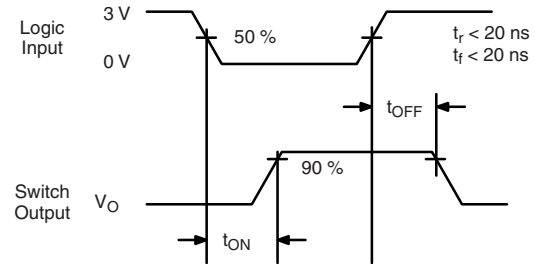
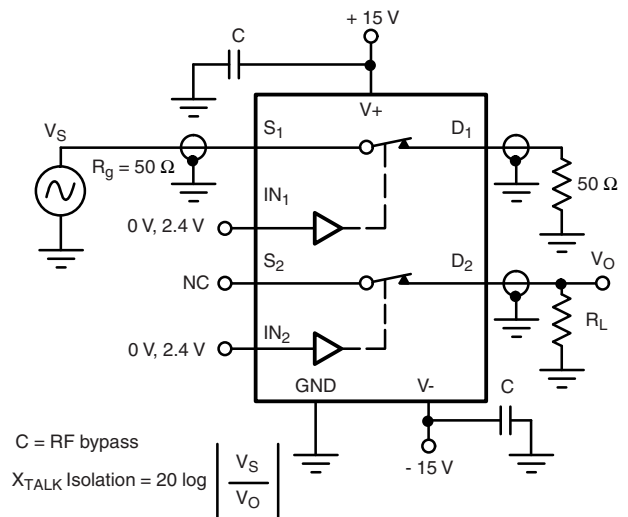
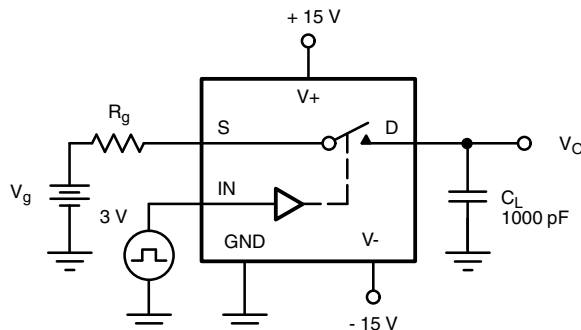
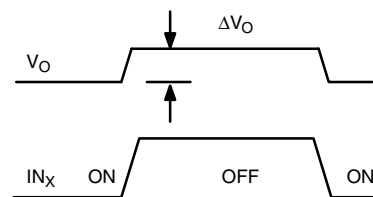
$Q_S$ ,  $Q_D$  - Charge Injection vs. Analog Voltage



Off Isolation vs. Frequency



Supply Current vs. Switching Frequency

**TEST CIRCUITS**

**Figure 2. Switching Time**

**Figure 3. Off Isolation**

**Figure 4. Channel-to-Channel Crosstalk**

**Figure 5. Charge Injection**


$\Delta V_O$  = measured voltage error due to charge injection  
The charge injection in coulombs is  $Q = C_L \times \Delta V_O$

## APPLICATIONS

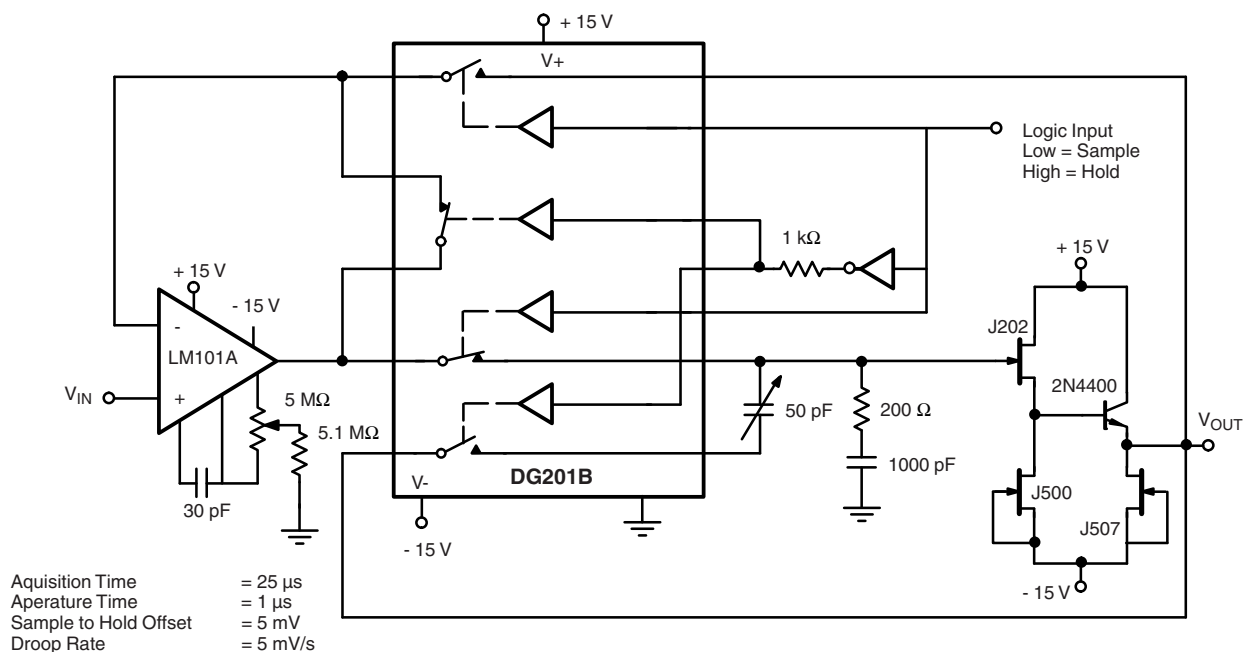


Figure 6. Sample-and-Hold

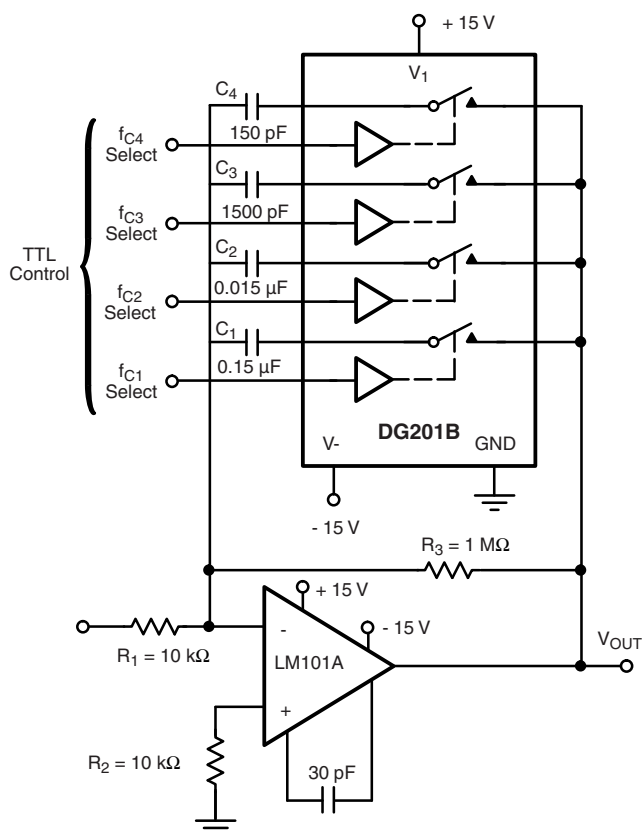
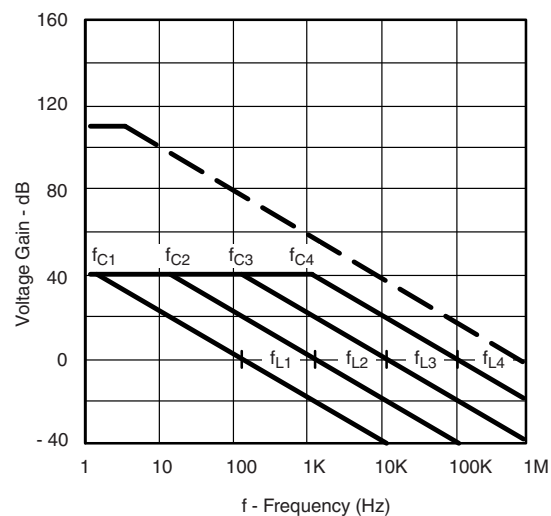


Figure 7. Active Low Pass Filter with Digitally Selected Break Frequency

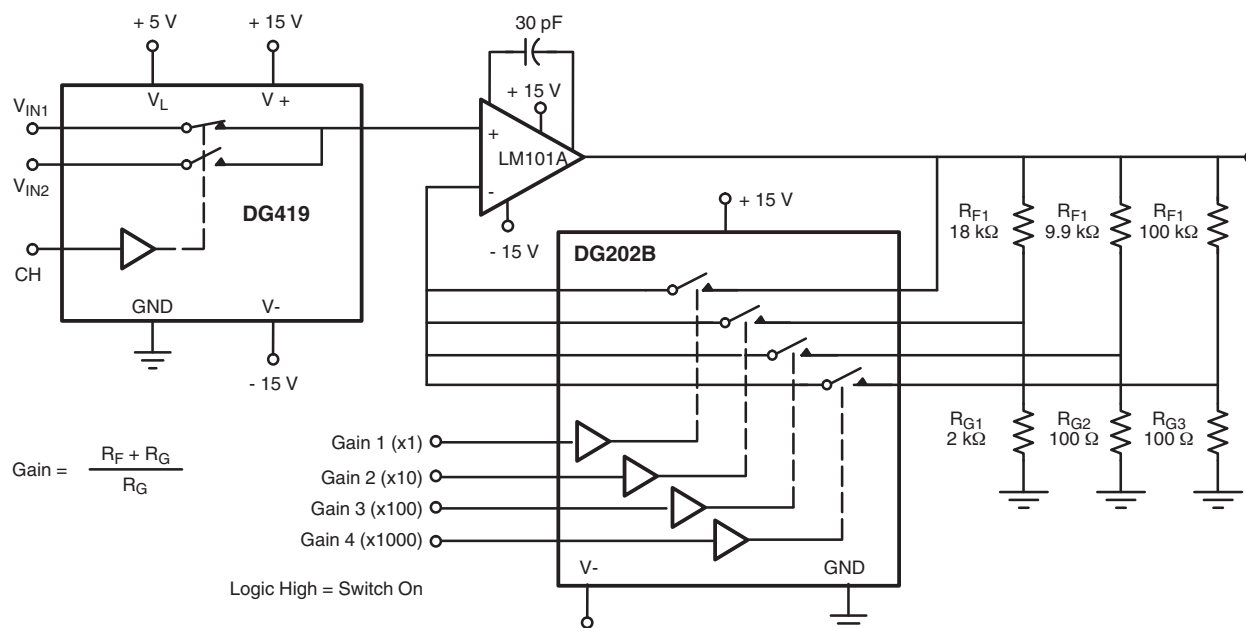


$$A_L \text{ (Voltage Gain Below Break Frequency)} = \frac{R_3}{R_1} = 100 \text{ (40 dB)}$$

$$f_C \text{ (Break Frequency)} = \frac{1}{2\pi R_3 C_X}$$

$$f_L \text{ (Unity Gain Frequency)} = \frac{1}{2\pi R_1 C_X}$$

$$\text{Max. Attenuation} = \frac{R_{DS(on)}}{10 \text{ k}\Omega} \approx -47 \text{ dB}$$

**APPLICATIONS**

**Figure 8. A Precision Amplifier with Digitally Programmable Input and Gains**

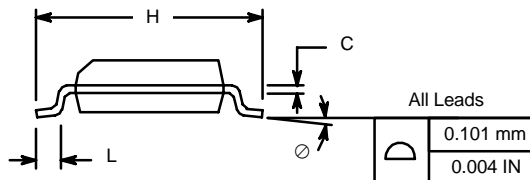
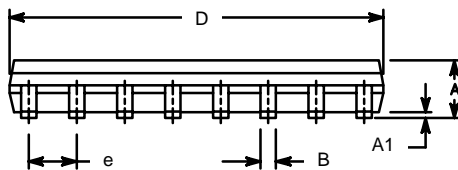
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### SOIC (NARROW): 16-LEAD

JEDEC Part Number: MS-012

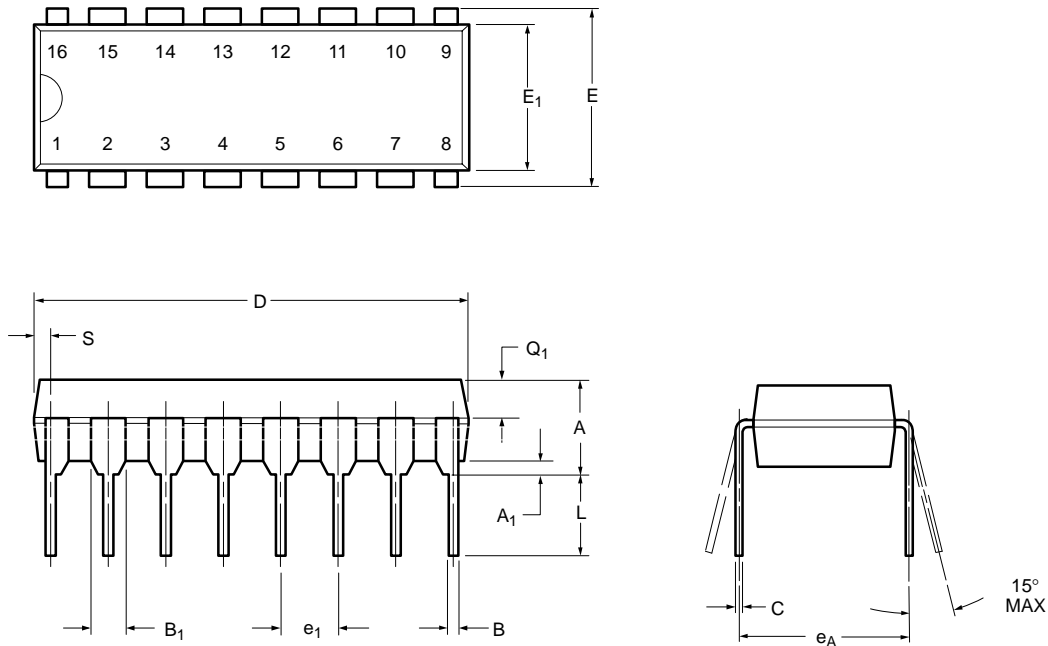


Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A <sub>1</sub>	0.10	0.20	0.004	0.008
B	0.38	0.51	0.015	0.020
C	0.18	0.23	0.007	0.009
D	9.80	10.00	0.385	0.393
E	3.80	4.00	0.149	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
L	0.50	0.93	0.020	0.037
⌀	0°	8°	0°	8°

ECN: S-03946—Rev. F, 09-Jul-01  
DWG: 5300



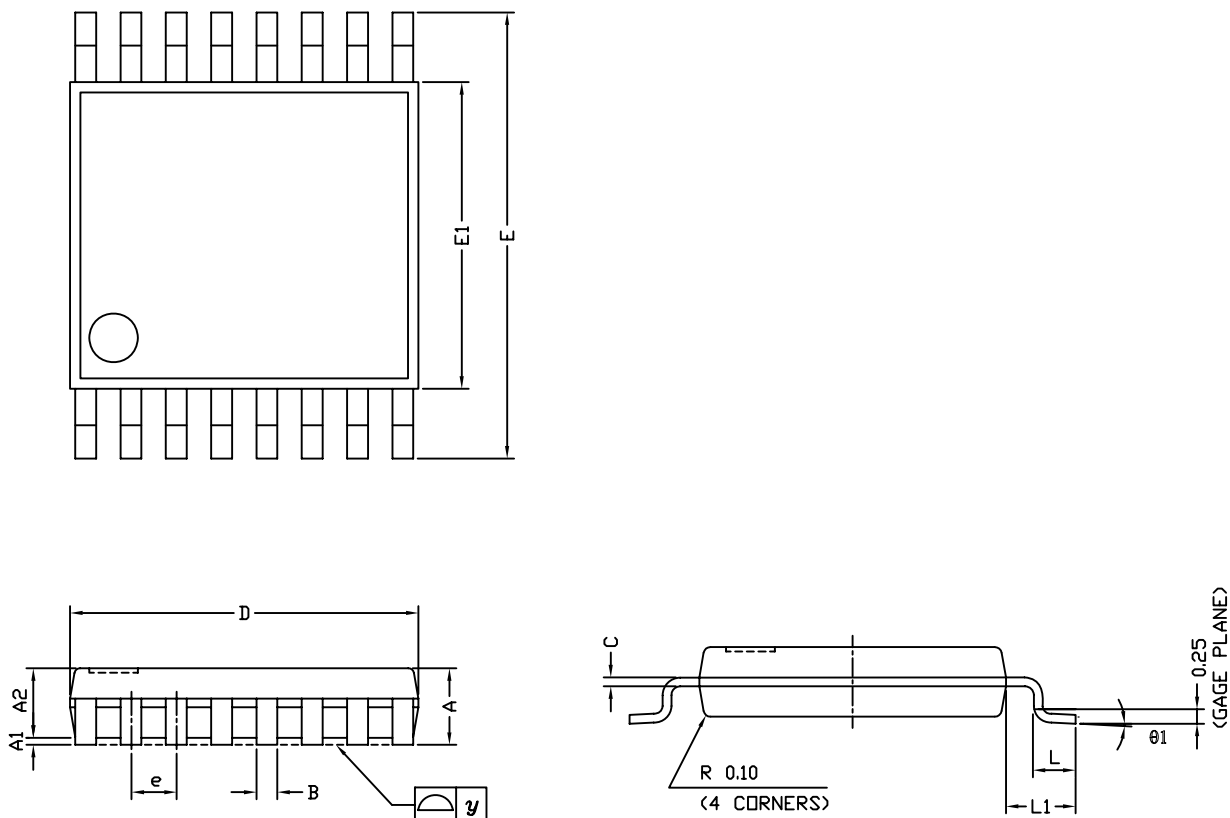
**PDIP: 16-LEAD**



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	3.81	5.08	0.150	0.200
A <sub>1</sub>	0.38	1.27	0.015	0.050
B	0.38	0.51	0.015	0.020
B <sub>1</sub>	0.89	1.65	0.035	0.065
C	0.20	0.30	0.008	0.012
D	18.93	21.33	0.745	0.840
E	7.62	8.26	0.300	0.325
E <sub>1</sub>	5.59	7.11	0.220	0.280
e <sub>1</sub>	2.29	2.79	0.090	0.110
e <sub>A</sub>	7.37	7.87	0.290	0.310
L	2.79	3.81	0.110	0.150
Q <sub>1</sub>	1.27	2.03	0.050	0.080
S	0.38	1.52	.015	0.060

ECN: S-03946—Rev. D, 09-Jul-01  
DWG: 5482

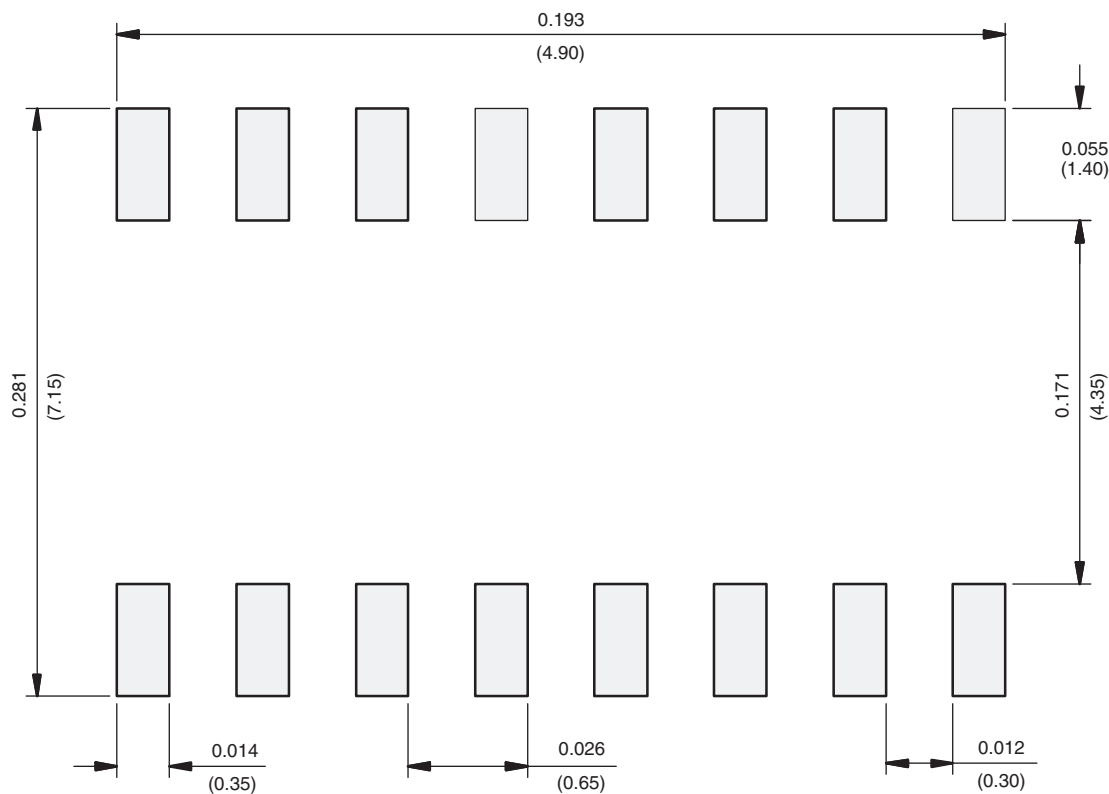
## TSSOP: 16-LEAD



Symbols	DIMENSIONS IN MILLIMETERS		
	Min	Nom	Max
A	-	1.10	1.20
A1	0.05	0.10	0.15
A2	-	1.00	1.05
B	0.22	0.28	0.38
C	-	0.127	-
D	4.90	5.00	5.10
E	6.10	6.40	6.70
E1	4.30	4.40	4.50
e	-	0.65	-
L	0.50	0.60	0.70
L1	0.90	1.00	1.10
y	-	-	0.10
θ1	0°	3°	6°
ECN: S-61920-Rev. D, 23-Oct-06			
DWG: 5624			

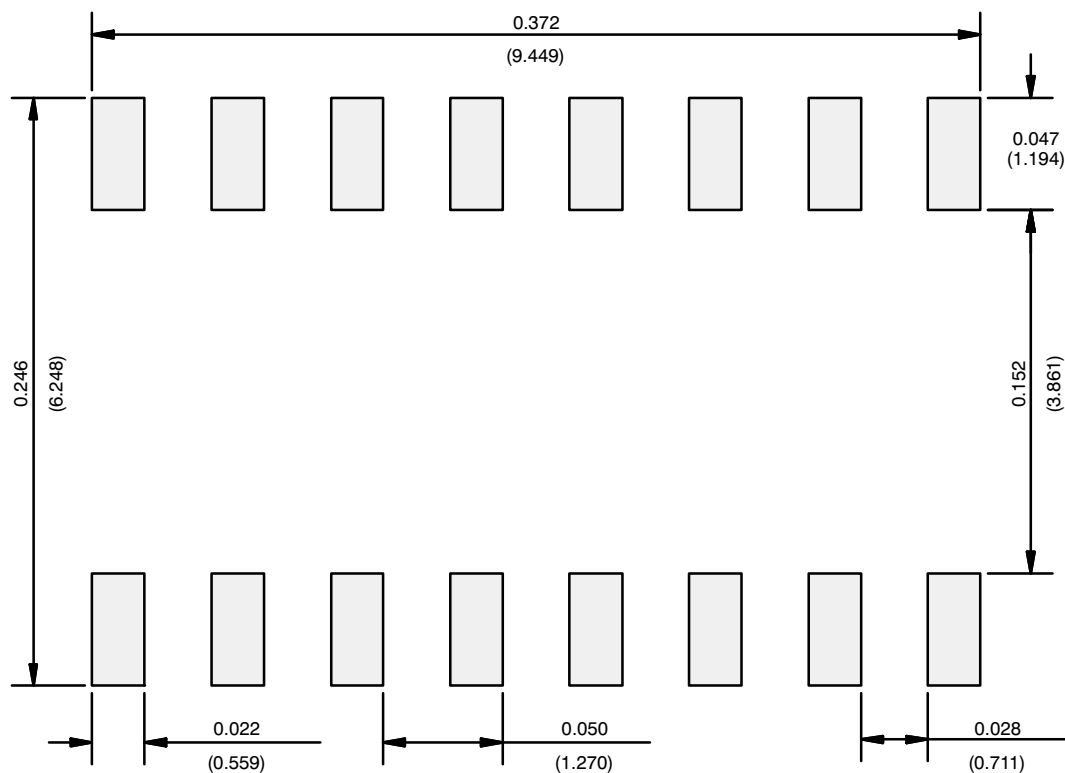


## RECOMMENDED MINIMUM PAD FOR TSSOP-16



Recommended Minimum Pads  
Dimensions in inches (mm)

## RECOMMENDED MINIMUM PADS FOR SO-16



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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